Document Number: XTAN60007C6 Preliminary Datasheet V1.0

# Gallium Nitride 12V, 7W,6GHz RF Power Transistor

### **Description**

The XTAN60007C6 is a 7watt, CW capable. GaN HEMT, ideal for multiple application up to 6GHz. It features high gain, high efficiency and low cost, in 10\*6mm plastic open cavity package, enabling surface mounted on PCB through grounding vias directly.

 Typical Class AB RF CW performance with device soldered through grounding vias Vds=12V, Idq=10mA

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Freq	P1dB	P1dB	P1dB	P1dB	P3dB	P3dB	P3dB
(MHz)	(dBm)	(W)	Eff(%)	Gain(dB)	(dBm)	(W)	Eff(%)
5100	38. 93	7.8	50.7	11.86	40.34	10.8	56. 7
5200	38. 91	7.8	52.8	11.62	40. 23	10.5	58. 5
5300	38.68	7.4	<b>54.</b> 3	11.51	40.02	10.0	60.0
5400	38. 36	6.9	54.8	11.4	39.75	9.5	60.7
5500	38. 33	6.8	56.9	11.46	39. 7	9.3	63.4
5600	38. 24	6. 7	59.2	11.63	39. 53	9.0	65.3
5700	37.86	6. 1	58. 7	11.71	39. 21	8.3	64.8
5800	37.6	5.8	57. 2	11.66	38.99	7. 9	62.6
5900	37. 47	5.6	55. 5	11.49	38. 94	7.8	60.8

### **Applications**

- UHF/L/S/C band power amplifier
- 5.8G WIFI amplifier
- 2.45G ISM application

#### **Important Note: Proper Biasing Sequence for GaN HEMT Transistors**

#### **Turning the device ON**

- 1. Set VGS to the pinch--off (VP) voltage, typically -5 V
- 2. Turn on VDS to nominal supply voltage
- 3. Increase VGS until IDS current is attained
- 4. Apply RF input power to desired level

#### Turning the device OFF

- 1. Turn RF power off
- 2. Reduce VGS down to VP, typically -5 V
- 3. Reduce VDS down to 0 V
- 4. Turn off VGS

### **Table 1. Maximum Ratings**

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Rating	Symbol	Value	Unit	
DrainSource Voltage	V <sub>DSS</sub>	+80	Vdc	
GateSource Voltage	V <sub>GS</sub>	-8 to +0.5	Vdc	
Operating Voltage	V <sub>DD</sub>	18	Vdc	
Maximum gate current	Igs	5	mA	
Storage Temperature Range	Tstg	-65 to +150	°C	
Case Operating Temperature	T <sub>C</sub>	+150	°C	
Operating Junction Temperature	TJ	+225	°C	

#### **Table 2. Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case by FEA	Do 10	4.5	°C /W
T <sub>c</sub> = 85°C, at Pout=7W CW, mounted on high density vias	Rejc	4.5	-0 /00



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Table 3. Electrical Characteristics (TA = 25℃ unless otherwise noted)

#### DC Characteristics (measured on wafer prior to packaging)

Characteristic	Conditions	Symbol	Min	Тур	Max	Unit
Drain-Source Breakdown Voltage	VGS=-8V; IDS=5mA	V <sub>DSS</sub>		80		V
Gate Threshold Voltage	VDS =10V, ID =5mA	$V_{GS(th)}$	-4	-3	-2	V
Gate Quiescent Voltage	VDS =12V, IDS=10mA, Measured in Functional Test	$V_{GS(Q)}$		-2.4		V

#### **Ruggedness Characteristics**

Characteristic	Conditions	Symbol	Min	Тур	Max	Unit
Load mismatch capability	6GHz, Pout=7W pulse CW					
	All phase,	VSWR		10:1		
	No device damages					

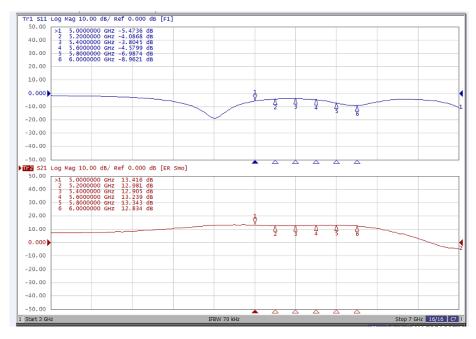
Figure 1:Pin Definition(Top View)



Pin No.	Symbol	Description
8,9,10,11,14,15,16,17	Vgs/RF In	Vgs and RF input
26,27,28,29,32,33,34,35	Vds/RF out	Vds and RF output
2,5,7,12,13,18,20,23,25,30,31,36	GND	DC/RF Ground
Package Base	GND	DC/RF Ground.
Others	NC	

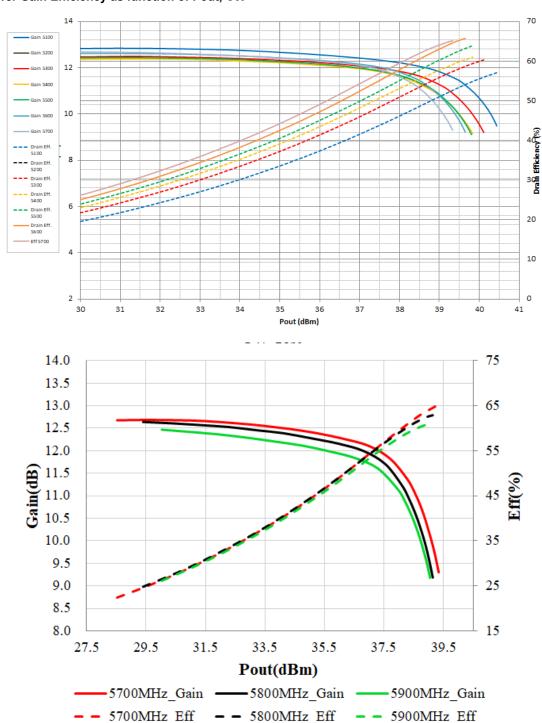
# **Typical characters**

Figure 2: Network analyser output S11/S21



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Figure 3: Power Gain Efficiency as function of Pout, CW



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Figure 4: Picture of application board

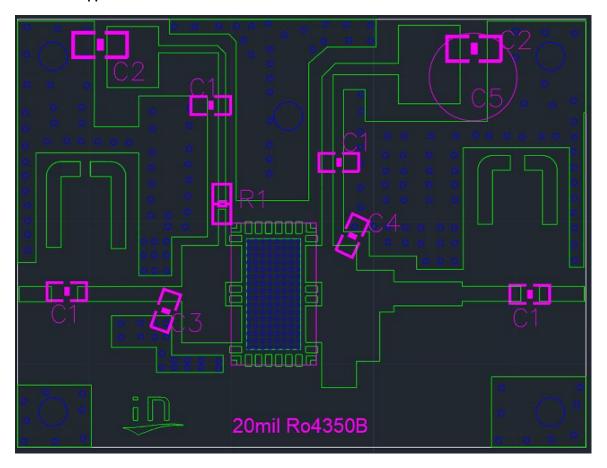
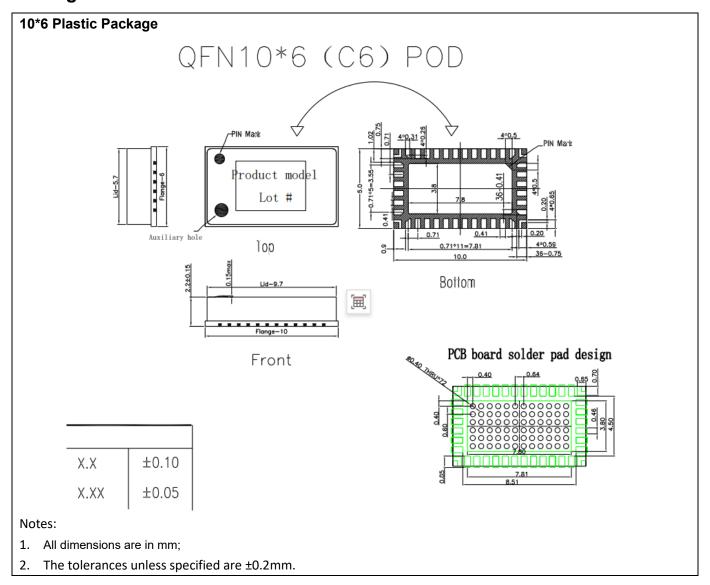


Table 4. Bill of materials of application board (RO4350B 20mils,PCB layout upon request)

Component	Value	Quantity
C1	3.9pF	4
C2	10uF	2
R1	10 ohm	1
C3	0.2pF	1
C4	0.3pF	1
C5	470uF	1

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## **Package Dimensions**



## **Revision history**

**Table 4. Document revision history** 

Date	Revision	Datasheet Status
2025/6/30	V1.0	Preliminary Datasheet Creation

Application data based on: ZXY-25-0825-24

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